

CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, AC SERIES (X1:500V~/Y2:500V~/1500Vdc)

POE-D26-00-E-05

Ver: 05

Page: 1/20



# PRODUCT SPECIFICATION

PRODUCT: CAPACITOR SAFETY RECOGNIZED

> **AC SERIES TYPE:** (X1:500V-/Y2:500V-/1500Vdc)

**CUSTOMER:** 

DOC. NO.: POE-D26-00-E-05

符合 RoHS&HF 及其他環保要求;金屬電鍍層不含六價鉻 RoHS &HF& Requirements of Environmental; Prohibit containing Cr+6 in the plating with metal

# APPROVED BY CUSTOMER

**VENDOR**: ■ WALSIN TECHNOLOGY CORPORATION 566-1, KAO SHI ROAD, YANG-MEI TAO-YUAN, TAIWAN ☐ PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO.,LTD. NO.277, HONG MING ROAD, EASTERN SECTION, HUANGPU DISTRICT, GUANG ZHOU, CHINA DONGGUAN WALSIN TECHNOLOGY ELECTRONICS CO., LTD. NO.638, MEI JING WEST ROAD, XINIUPO, ADMINISTRATIVE ZONE, DALANGTOWN, DONGGUAN CITY, GUANGDONG PROVINCE **MANUFACTURE SITE:** V PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO.,LTD.

NO.277, HONG MING ROAD, EASTERN SECTION, HUANGPU DISTRICT, GUANG ZHOU, CHINA



CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, AC SERIES (X1:500V~/Y2:500V~/1500Vdc)

POE-D26-00-E-05

Ver : 05

Page: 2/20

## **Record of change**

Date	Version	Description	page
2018/3/20	00	1. First edition.	All
		Review the Available lead code of Lead Configuration	5
2019/12/29	01	2. Add "8.3 Label samples"	14
2021/9/9	02	1. Delete Walsin & POE logo.	1
2022/4/21	03	<ol> <li>Add Applied voltage in 9.3 Test condition for withstanding voltage.</li> <li>Add 10.2 List of substances that affect the insulation strength of coating</li> </ol>	15~16 18
2023/5/26	04	Revised recognized No. of SEMKO and FIMKO.	9
2023/9/25	05	1. Review the bulk packing quantity of the code of 14th to 15th $\ge$ 12	14





CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, POE-D26-00-E-05 Ver : 05 Page: 3/20 AC SERIES (X1:500V~/Y2:500V~/1500Vdc)

## **Table of Contents**

No.	Item	Page
1	Part number for SAP system	4
2	Mechanical	5
3	Part numbering/T.C/Capacitance/ Tolerance/Diameter	6
4	Taping Format	7
5	Marking	8
6	Scope	9
7	Specification and test method	10~13
8	Packing specification	14
9	Caution	15~17
10	Notice	17~18
11	Note	18
12	Soldering Recommendation	19
13	Drawing of Internal Structure and material list	20





CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, POE-D26-00-E-05 Ver: 05 Page: 4/20 AC SERIES (X1:500V~/Y2:500V~/1500Vdc)

### 1. Part number for SAP system

(Ex.)

(1) Temperature characteristic (identified code)

CODE	Temperature characteristic	Cap. Change
SL	SL	-1000~+350ppm/°C (+20°C~+85°C)
YP	B (Y5P)	±10%
YU	E (Y5U)	-55% to +20%
YV	F (Y5V)	-80% ~ +30%

(2)-1 Rated voltage(identified by 1-figure code) : 5=X1:500V~/Y2:500V~/1500Vdc

(2)-2 Type(identified by 2-figure code): AC

(3) Capacitance (identified by 3-figure code) : ex.221=220pF

(4) Capacitance tolerance (identified by code) : J:±5%,K:±10%,M:±20%

(5) Nominal body diameter dimension (Refer to "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter")

(6) Internal code: 0--Normal, other code--Special control

(7) Lead Style: Refer to "2. Mechanical".

(8) Packing mode and lead length (identified by 2-figure code): Refer to "2. Mechanical" & "4.Taping Format"

Taping Code	Description	1
AF	Ammo box and product pitch: 15.0 mm	
AM	Ammo box and product pitch: 25.4 mm	

Bulk Code	Description EIVE SYSTEM ALL
03	Lead length ÷ 3.0mm
3E	Lead length : 3.5mm
04	Lead length: 4.0mm

(9) Tolerance of lead length

Code	Description	Yology
A	±0.5 mm	Short lead
В	±1.0 mm	Short lead
С	Min.	Long lead
D	Taping special purpose	Taping

(10) Lead space

Code	Description
7	7.5±1.0 mm
M	7.5±0.5 mm
0	10±1.0 mm
A	10±0.5 mm

(11) Epoxy resin code

Code	Description
Н	Halogen and Pb free, epoxy resin.



CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, POE-D26-00-E-05 Ver: 05 Page: 5/20 AC SERIES (X1:500V~/Y2:500V~/1500Vdc)

#### 2. Mechanical

Encapsulation: Epoxy resin, flammability UL94 V-0

Available lead code(unit: mm)

Available lead code(	unit: mm)	т	T	T			
Lead type	SAP P/N (13-17)digits	Lead space (F)	Lead Length (L)	Packing	Lead Configuration		
	L03B7	$7.5 \pm 1.0$	$3.0 \pm 1.0$				
	L4EB7	$7.5 \pm 1.0$	$4.5 \pm 1.0$				
	L05B7	$7.5 \pm 1.0$	$5.0 \pm 1.0$		D max. T max.  +		
	L03B0	$10 \pm 1.0$	$3.0 \pm 1.0$	D 11			
Lead style: L or B	L4EB0	10 ± 1.0	4.5 ± 1.0	Bulk	( ) For		
Type L or B	L05B0	$10 \pm 1.0$	5.0± 1.0		L≧20mm		
Straight lead	L20C7	7.5 ±1.0	20 min.		P THE F		
C	L20C0	10 ± 1.0	20 min.		For		
	BAFD7		<u> </u>		L<20mm pd -		
	BAMD7	Refer to "4. T	'aping format''	Tap. Ammo			
	BAMD0			_			
	G03A7	$7.5 \pm 1.0$	$3.0 \pm 0.5$		D max. T max.		
	G3EA7	$7.5 \pm 1.0$	$3.5 \pm 0.5$				
	G04A7	$7.5 \pm 1.0$	$4.0 \pm 0.5$	D 11			
Lood style : C	G03A0	$10 \pm 1.0$	$3.0 \pm 0.5$	Bulk	/		
Lead style: G	G3EA0	$10 \pm 1.0$	$3.5 \pm 0.5$	Fix	\		
Type G	G04A0	$10 \pm 1.0$	$4.0 \pm 0.5$	2 50			
Straight lead	GAFD7	7.5 ±1.0			6 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		
	GAMD7	7.5 ±1.0	Refer to "4. Taping format"	Tap. Ammo	F III I		
	GAMD0	$10 \pm 1.0$	1 0	See	[] % q + [] + [] []		
	D03A7	$7.5 \pm 1.0$	$3.0 \pm 0.5$	7 8	D max. T max		
	D3EA7	$7.5 \pm 1.0$	$3.5 \pm 0.5$	5 85			
Lead style: D	D04A7	$7.5 \pm 1.0$	$4.0 \pm 0.5$	Bulk			
	D03A0	$10 \pm 1.0$	$3.0 \pm 0.5$		( )		
m 5	D3EA0	10/±/1.0	$3.5 \pm 0.5$	. ( )	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		
Type D	D04A0	10 ± 1.0///	$4.0 \pm 0.5$				
Vertical kink lead	DAFD7 DAMD7				<del>   </del>		
	DAMD0	Refer to "4. T	'aping format''	Tap. Ammo	∅ d→		
	X03A7	$7.5 \pm 1.0$	$3.0 \pm 0.5$		D max. T max.		
	X3EA7	$7.5 \pm 1.0$	$3.5 \pm 0.5$	1	D max. ⊤ max.		
	X04A7	$7.5 \pm 1.0$	$4.0 \pm 0.5$	1			
Lead style: X	X05B7	$7.5 \pm 1.0$	$5.0 \pm 1.0$	D.,11-			
·	X03A0	$10 \pm 1.0$	$3.0 \pm 0.5$	Bulk	( )		
	X3EA0	$10 \pm 1.0$	$3.5 \pm 0.5$		l .₁λ ⟨		
Type X	X04A0	$10 \pm 1.0$	$4.0 \pm 0.5$		ğ · L		
Outside kink lead	X05B0	$10 \pm 1.0$	$5.0 \pm 1.0$		x v v v v v v v v v v v v v v v v v v v		
	XAFD7			Tap. Ammo	vitjit F → Hi Hi		
	XAMD7	Refer to "4. T	'aping format''		'   ød-+  -    ∟		
	XAMD0				u U <u>Ц+</u>		

<sup>\*</sup> Lead diameter  $\Phi$ d: 0.55+0.1/-0.05mm

<sup>\*</sup> e (Coating **extension** on leads): 3.0mmMax for straight lead style; Not exceed the kink for kink lead.



CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, POE-D26-00-E-05 Ver : 05 Page: 6/20 AC SERIES (X1:500V~/Y2:500V~/1500Vdc)

### 3. Part numbering/T.C/Capacitance/ Tolerance/Diameter:

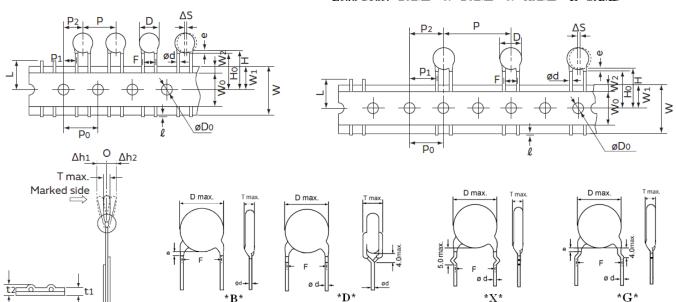
					Di	mension	s (unit: mm)	)
SAP Part. No.	T.C.	Capacitance	Tolerance	D	(max)		F	
B111 1 411. 1 (0.	1.0.		Toloranoe	(max)		Bulk	Taping	φd
		10,12,15,18,20,22,2				type	type	
SL5AC***J060*		4,27,30,33,	±5%	7.0				
		36,39,47,50,51(pF)						
SL5AC***J070*	SL	56,62, 68,75(pF)	±5%	8.0				
SL5AC820J080*		82pF	±5%	9.0				
SL5AC101J090*		100pF	±5%	10.0				
YP5AC101K060*		100 pF	$\pm 10\%$	7.0			7.5±1	
YP5AC151K060*		150 pF	±10%	7.0			(AFD7) Or	
YP5AC221K060*		220 pF	±10%	7.0			$10 \pm 1$	
YP5AC331K060*		330 pF	±10%	7.0			(AMD0)	
YP5AC471K060*	Y5P	470 pF	±10%	7.0				
YP5AC561K070*		560pF	±10%	8.0				
YP5AC681K070*		680 pF	±10%	8.0				
YP5AC821K080*		820 pF	±10%	9.0				
YP5AC102K080*		1000 pF	±10%	9.0				
YU5AC102M060*		1000 pF	±20%	7.0			7.5±1	
YU5AC152M080*		1500 pF	±20%	9.0	5.0	7.5±1,	(AFD7) 0.55	0.55+0.1/-0.05
YU5AC222M080*		2200 pF	±20%	9.0		10±1	Or 10±1	0.00
YU5AC332M100*	Y5U	3300 pF	±20%	11.0	TT		(AMD0)	
YU5AC392M120*	130	3900 pF	±20%	13.0	一		7.5±1 (AMD7)	
10011009201120		Hu	=2070	10.0	711	\	Or	
YU5AC472M120*		4700 pF	±20%	13.0			10±1	
VIV.5 A C100 A0 C0 \$		1000 F 7055	200/554	7.0155			(AMD0)	
YV5AC102M060*	_	1000 pF PASS	200€	7.0		LD,	7.5 . 1	
YV5AC152M060*	_	1500 pF	±20%	7.0	.2 <u>E</u>	Alle	7.5±1 (AFD7)	
YV5AC222M060*		2200 pF	±20%	7.0	6		Or	
YV5AC332M080*		3300 pF	±20%	9.0			$10 \pm 1$	
YV5AC392M100*	Y5V	3900 pF	±20%	11.0	0/2		(AMD0)	
YV5AC472M100*		4700 pF//	±20%	11.0				
YV5AC682M120*		6800 pF	/// <u>±20</u> %	13.0			7.5±1 (AMD7)	
YV5AC103M140*		10000 pF	±20%	15.0			Or 10±1 (AMD0)	
							(AMD0)	

CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, POE-D26-00-E-05 Ver: 05 Page: 7/20 AC SERIES (X1:500V~/Y2:500V~/1500Vdc)

### 4. Taping Format

• 15 mm pitch/lead spacing 7.5mm taping Lead Code: \*BAFD7 & \*DAFD7 & \*XAFD7 &\*GAFD7

• 25.4mm pitch/lead spacing 7.5mm & 10.0mm taping Lead Code: \*BAMD\* & \*DAMD\* & \*XAMD\* &\*GAMD\*



POE Part Number	*BAFD7 / *DAFD7 *XAFD7 / *GAFD7	*BAMD7 / *DAMD7 *XAMD7 / *GAMD7	*BAMD0 / *DAMD0 *XAMD0 / *GAMD0		
Item	Symbol	Dimensions (mm)	Dimensions (mm)	Dimensions (mm)	
Pitch of component	/// P	15.0±1.0	25.4±2.0	25.4±2.0	
Pitch of sprocket	P0	15.0±0.3	12.7±0.3	12.7±0.3	
Lead spacing	FASSIV	7.5±1.0	7.5±1.0	10.0±1.0	
Length from hole center to component center	P2	7.5±1.5	12.7±1.5	12.7 ± 1.5	
Length from hole center to lead	P1	3.75±1.0	8.95±1.0	7.7±1.5	
Body diameter	D	See the "3. Part num	nbering/T.C/Capacitance/	Tolerance/Diameter"	
Deviation along tape, left or right	ΔS	6/10	0±2.0		
Carrier tape width	//S//W	hology	18.0 +1/-0.5		
Position of sprocket hole	W1////	MOCY CORROBATION.	9.0±0.5		
Lead distance between the kink and center of	.,,,,,	18.0+2.0/-0	18.0+2.0/-0	18.0+2.0/-0	
sprocket hole	H0		(For: *DAMD7 / *XAMD7 /		
sprooner nore		*GAFD7)	*GAMD7)	*GAMD0)	
Lead distance between the bottom of body	Н	20.0+1.5/-1.0	20.0+1.5/-1.0	20.0+1.5/-1.0	
and the center of sprocket hole		(For: *BAFD7)	(For: *BAMD7)	(For: *BAMD0)	
Length from the terminal of the lead wire to the edge of carrier tape	$\ell$	+0.5 to -1.0 (Or the end of lead wire may be inside the hole-down tape.)			
Diameter of sprocket hole	D0	4.0±0.2			
Lead diameter	φd	0.55±0.05			
Total tape thickness	t1	0.6±0.3			
Total thickness, tape and lead wire	t2	1.5 max.			
Deviation across tape	Δ h1/Δ h2	2.0 max.			
Portion to cut in case of defect	L	11.0 max.			
Hole-down tape width	W0	8.0 min			
Hole-down tape distortion	W2	1.5±1.5			
Coating extension on leads	e	3.0 max for straight lead style; Not exceed the kink leads for kink lead.			
Body thickness	T	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"			



CERAMIC DISC CAPACITOR SAFETY RECOGNIZED,			
5AC SERIES	POE-D26-00-E-03	Ver : 03	Page: 8 / 20

### 5.Marking:

5.Marking ·					
1.Type Designation	5AC				
2.Nominal Capacitance	Identified by 3-Figure Code. Ex. 47pF→"47", 470pF→"471"				
3.Capacitance Tolerance	J:±5%,K:±10%,M:±20%				
4.Company Name Code(Trade mark)	l K				
5.Class code & Voltage	X1: 500V~/Y2: 500V~/1500Vdc				
6. Products ID	Abbreviation ex.				
	Manufacture year: ←2 C 0:2020 1:2021 2:2022 Manufactory: 3:2023 C:Pan overseas (Guangzhou) 1:9:September 0:October N:November D:December				
	Marking ex.				
	Two sides marking				
	K AC471K 2C61234 X1:500V~ Y2:500V~ 1500V				

\* Marking by the laser.

\* " • ": Individual specification code, it is added under the lot no.



CERAMIC DISC CAPACITOR SAFETY RECOGNIZED,			
5AC SERIES	POE-D26-00-E-03	Ver : 03	Page: 9 / 20

#### 6. Scope

THIS SPECIFICATION APPLIES TO CERAMIC INSULATED CAPACITORS DISK TYPE USED IN ELECTRONIC EQUIPMENT.

This specification applies to the UL/CUL, ENEC, FIMKO, approved ceramic capacitors disc type for antenna coupling, line-by-pass and across-the-line. X1, Y1 capacitor based on IEC384-14. "UL,ENEC recognized capacitor for across-the-line, line-by-pass" and antenna-isolation.

1. UL/CUL, ENEC, FIMKO recognized capacitor for Antenna coupling and AC line-by-pass.X1, Y2 Capacitor based on IEC 60384-14. "UL, ENEC recognized for across-the-line, line-by-pass" and antenna-isolation.

2. Approval Standard and Recognized No.

Safety Standard	Standard No.	Recognized No.	Rated Volt.
UL / CUL	ANSI/UL 60384-14:2013	E146544	
ENEC (DEMKO)	EN 60384-14	ENEC-01962	
SEV	EN 60384-14:2013 + A1:16	21.0555	
SEMKO	EN 60384-14:2013+A1	SE-S-1811994R2	X1:500Vac
FIMKO	EN 60384-14:2013 + A1:16	FI/41696	Y2:500Vac 1500Vdc
NEMKO	EN 60384-14:2013;A1	P18222947	1300 v uc
DEMKO	EN 60384-14:2013/ A1:2016 EN 60384-14:2013	D-07617	
CQC	IEC60384-14:2013	CQC15001121984	



	1	l	l
CERAMIC DISC CAPACITOR SAFETY RECOGNIZED,			
5AC SERIES	POE-D26-00-E-03	Ver : 03	Page: 10 / 20

### 7. Specification and test method

7.1 Operating Temperature Range: -40 to +125°C

#### 7.2 Test condition:

Test and measurement shall be made at the standard condition. (temperature 15~35 °C, relative humidity 45~75% and atmospheric pressure 860~1060hpa). Unless otherwise specified herein.

If doubt occurred on the value of measurement, and measurement was requested by customer capacitors shall be measured at the reference condition. (temperature  $20\pm2^{\circ}$ C or  $25\pm2^{\circ}$ C, relative humidity  $60\sim70\%$  and atmospheric pressure 860~1060hpa.)

#### 7.3 Performance:

No	It	em		Specification	n Testing Method					
1	Appearance a	nd dimensions	form and	ed defect on appearance dimensions. fer to [Part number list].	The capacito defect.  Dimensions s					ole evidence of
2				sily legible.	The capacito					
3	Dielectric Strength	Between terminals	No failure	, ,	The capacito applied between	r should een the le	not be da	amaged v	vhen AC2	n.s.) <50/60Hz> is
		Body Insulation	No failure		(Charge/Discharge current ≤50mA.)  First, the terminals of the capacitor should be connected together.  Then, a metal foil should be closely wrapped around the body of the capacitor to the distance of about 3 to 6mm from each terminal. Then, the capacitor should be inserted into a container filled with metal balls of about 1mm diameter.  Finally, AC2600V (r.m.s.)<50/60Hz> is applied for 60 s between the capacitor lead wires and metal balls. (Charge/Discharge current ≤ 50mA.)					
4	Insulation Res	istance(I.R.)	10000ΜΩ	l min.	The insulation resistance should be measured with DC500±50V within 60± 5 s of charging.  The voltage should be applied to the capacitor through a resistor of 1MΩ					
5	Capacitance		Within sp	ecified tolerance	•				•	
6	Dissipation Fa	actor(D.F.)	F(Y5V)	Specifications 2.5% max. 5.0% max. Q≥400+20C*₁(C<30pF) Q≥1000 (C≥30pF)	Y5P&Y5U&Y5V: The capacitance shall be measured at 20±2°C with 1kHz±20% and 1.0Vrms.  SL: The capacitance shall be measured at 25°C with 1MHz±20% and 1.0Vrms					
7	Temperature 0	Characteristic	(Temp. ra Char.	Capacitance Change Within ± 10% Within +20/-55% Within -80~+30%  nge: -25 to +85°C)  Capacitance Change -1000~+350 ppm/°C  nge: +20 to +85°C)	The capacitance measurement shall be made at each step specified in table  Step 1 2 3 4 5  Temp.(°C) +20±2 -25±2 +20±2 +85±2 +20±2  Pr-treatment:  Capacitor shall be stored at 125±2°C for 1 hour. Then placed at room condition*2 for 24±2 hours before measurement					

<sup>&</sup>quot;C" expresses nominal capacitance value (pF).

<sup>&</sup>quot;room condition" temperature: 15~35°C, humidity: 45~75%, atmospheric pressure: 86~106kPa



### CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, **5AC SERIES**

POE-D26-00-E-03

Ver: 03

Page: 11 / 20

No	Iter	n	Specification	Testing Method			
8	Robustness of terminations	As shown in the figure at right, fix the body of the capacitor and apply a tensile weight gradually to each lead wire in the radial direction of the capacitor up to 10N and keep it for 10±1 sec.					
		Bending	Lead wire shall not cut off capacitor shall not be broken.	or With the termination in its normal position, the specimen is held by its bod such a manner that the axis of the termination is vertical; a mass applying force of 5N is then suspended from the end of the termination. The body of specimen is then inclined, within a period of 2 to 3sec, through an angle approximately 90° in the vertical plane and then returned to its initial position over the same period of time; this operation constitutes one bend. One be immediately followed by a second bend in the opposite direction.			
9	Soldering Effect	Appearance	No marked defect	As shown in figure, the lead wires should be immersed in solder of 350 $\pm$ 10 $^{\circ}$ C			
	(Non-Preheat)	I.R.	1000MΩ min.	or $260 \pm 5$ °C up to 1.5 to 2.0mm from the root of			
		Dielectric Strength	Per Item 3.	Terminal for $3.5 \pm 0.5$ sec ( $10 \pm 1$ sec for $260 \pm 5$ °C )  Thermal Capacitor			
		Capacitance Change	B(Y5P),E(Y5U),F(Y5V): Within ±10% SL: Within±2.5% or ±0.25pF,Whichever is large.	Screen. 1.5			
10	Soldering Effect	Appearance	No marked defect.	First the capacitor should be stored at $120 + 0 / -5$ °C for $60 + 0 / -5$ sec.			
	(On-Preheat)	I.R.	1000MΩ min.	Then, as in figure , the lead wires should be immersed solder of 260 + / -5 $^{\circ}$ C			
		Dielectric Strength	Per Item 3.	up to 1.5 to 2.0 mm from the root of terminal for 7.5 +0 / -1 sec.  Thermal Screen 1.5			
		Capacitance Change	B(Y5P),E(Y5U),F(Y5V): Within ±10% SL: Within±2.5% or ±0.25pF, Whichever is large.	Pre-treatment: Capacitor shall be stored at 125±2°C for 1hour.then placed at  **1room condition for 24±2hours before initial measurements.  Post-treatment: Capacitor shall be stored for 1 to 2hours at **1room condition.			
11	Solderability of lea	ds	Lead wire should be soldered with uniform coating on the axial direction over 3/4 of the circumferential direction	The lead wire of capacitor should be dipped into molten solder for $5 \pm 0.5$ sec. The depth of immersion is up to about 1.5 to 2.0 mm from the root of lead wires. Temp. of solder : Lead free solder (Sn97 -Cu3) $245 \pm 5  ^{\circ}\text{C}$			
12	the		The burning time shall not be exceeded the time 30 sec. The tissue paper shall not ignite.				

<sup>&</sup>quot;room condition" temperature: 15~35°C, humidity: 45~75%, atmospheric pressure: 86~106kPa



### CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, **5AC SERIES**

POE-D26-00-E-03

Ver : 03

Page: 12 / 20

No	Item	1	Specification	Testing Method
13	Life	Appearance	No marked defect.	Impulse Voltage:
		Capacitance	B(Y5P),E(Y5U),F(Y5V):	Each individual capacitor shall be subjected to 5kv impulses for three times.
		Change	Within ±20%	After the capacitors are applied to life test.
			SL: Within±3% or ±0.3pF,	The waveform will be determined by the test circuit parameters. Details of
			Whichever is large.	the test circuit are given in IEC 60384-14 Annex A.
				100 (%) 90 Front time (T1) =1.2μs=1.67T
		I.R.	B(Y5P),E(Y5U),F(Y5V):	Time to half-value (T2) =50us
			$3000 \mathrm{M}\Omega$ min.	50
			SL: 1000MΩ min.	30-
		Dielectric	Per Item 3.	t
		Strength		   T <sub>1</sub>
				<del>← T</del> 2
				The specimen capacitors are placed in a circulating air oven for a period of
				1000 hrs. The air in the oven is maintained at a temperature of $125\pm2^{\circ}$ C.
				Throughout the test. The capacitors are subjected to an AC850Vrms alternating
				voltage of mains frequency.  Pre-treatment: Capacitor shall be stored at 125±2°C for 1hour.then placed at
				**Iroom condition for 24±2hours before initial measurements.
				Post-treatment: Capacitor shall be stored for 1 to 2hours at **1room condition.
14	Active Flammability	y	The cheesecloth shall not be on	The specimens shall be individually wrapped in at least one but more then two
			fire.	complete layers of cheesecloth. The specimens shall be subjected to 20
				discharges. The interval between successive discharges shall be 5sec. The Uac
				shall be maintained for 2 min. after the last discharge.  F L1 L2 R
				$\begin{array}{c ccccccccccccccccccccccccccccccccccc$
				UAC   13   14
				Tr
				' Ц
				Osciloscope
				C1,2: 1uF±10% C3: 0.033uF±5% 10KV
				L1-4: 1.5mH±20% 16A Rod core choke
				R : 100Ω±2% Ct : 3uF±5% 10KV
				Uac: Ur±5% Ur: Rated working voltage
				Cx : Capacitor F : Fuse, Rated 10A  Ut : Voltage applied to Ct
				Ux
				5kV
				300
ш				time

<sup>&</sup>quot;room condition" temperature : 15~35°C , humidity : 45~75%, atmospheric pressure : 86~106kPa



### CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, **5AC SERIES**

POE-D26-00-E-03

Ver: 03

Page: 13 / 20

No	Iten	n	Specification	Testing Method			
15	Humidity	Appearance	No marked defect	Set the capacitor for $500\pm12$ hours at $40\pm2^{\circ}$ C, in 90 to 95%			
13	(Under Steady State)	Capacitance Change	B(Y5P): Within ±10% E(Y5U): Within ±20% F(Y5V): Within ±30% SL: Within±2.5% or ±0.25pF, Whichever is large.	humidity.  Pre-treatment: Capacitor shall be stored at 125±2°C for 1hour.then placed at **1room condition for 24±2hours before initial			
		D.F. Q I.R. Dielectric strength		measurements.  Post-treatment: Capacitor shall be stored for 1 to 2hours at **1ro condition.			
16	Humidity Loading	Appearance Capacitance Change	No marked defect  B(Y5P): Within ±10%  E(Y5U): Within ±20%  F(Y5V): Within ±30%  SL: Within±2.5% or ±0.25pF,  Whichever is large.	Apply the rated voltage for 500±12 hours at 40±2°C, in 90 95% humidity.  Pre-treatment: Capacitor shall be stored at 125±2°C for 1hour.then place at **1room condition for 24±2hours before initial measurements.			
		D.F. Q	$\begin{array}{ll} \text{Char.} & \text{Specifications} \\ \text{B(Y5P)} & 5.0\% \text{ max.} \\ \text{E(Y5U)} & 5.0\% \text{ max.} \\ \\ \text{F(Y5V)} & 7.5\% \text{ max.} \\ \text{SL} & Q \! \geq \! 100 \! + \! 10 \! \times \! \text{C} \! / 3^{\oplus 2} (\text{C} \! < \! 30 \text{pF}) \\ \text{Q} \! \geq \! 200  (\text{C} \! \geq \! 30 \text{pF}) \end{array}$	Post-treatment: Capacitor shall be stored for 1 to 2hours at **1room condition.			
		I.R. Dielectric strength	B(Y5P),E(Y5U),F(Y5V) : 3000M $\Omega$ min. SL : 1000M $\Omega$ min. Per Item 3				
17	Temperature Cycle	Appearance Capacitance Change	No marked defect  Char. Capacitance Change B(Y5P) Within ± 10% E(Y5U) F(Y5V) Within ± 20% SL Within ± 10%	The capacitor should be subjected to 5 temperature cycles,			
		D.F. Q	Char.         Specifications           B(Y5P)         5.0% max.           E(Y5U)         7.5% max.           F(Y5V)         Q≥275+5/2C *2 (C<30pF)	Pre-treatment:  Capacitor shall be stored at 125±2°C for 1hour.then plac at *1room condition for 24±2hours.  Post-treatment:  Capacitor shall be stored for 1 to 2hours at *1room condition.			
		I.R. Dielectric strength	3000MΩ min. Per Item 3				

<sup>&</sup>quot;room condition" temperature  $\div$  15~35°C , humidity  $\div$  45~75%,atmospheric pressure  $\div$  86~106kPa \*

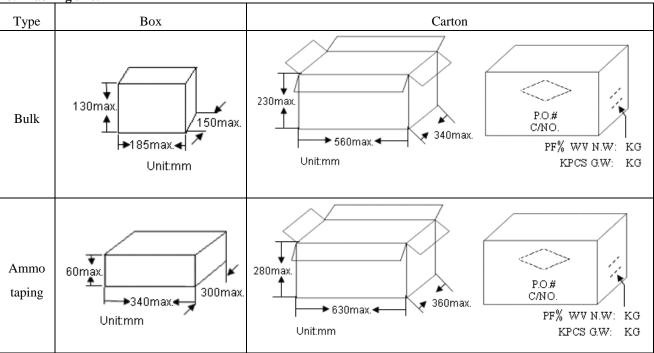
<sup>&</sup>quot;C" expresses nominal capacitance value (pF).



CERAMIC DISC CAPACITOR SAFETY RECOGNIZED,	DOE D2 ( 00 E 02	** 00	D 11/20
5AC SERIES	POE-D26-00-E-03	ver : 03	Page: 14 / 20

### 8. Packing Baggage:

8.1 Packing size:



8.2 Packing quantity:

Packing type	The code of 14th to15th in SAP P/N	MPQ(Kpcs/Box)
	AF	1
Taping	AM (The size code $\leq 11$ )	1
	AM (The size code ≥ 12)	0.5

Packing type	Lead length	Size code of 10th to 11th in SAP P/N	MPQ (Kpcs/Bag)	Kpcs/Box
Bulk	Long lead	06~12	0.5	1.5
	$(L \ge 20 mm)$	13-14	0.5	1
	Short lead	06~12	0.5	2
	(L<20mm)	13-14	0.5	1.5

#### 8.3 Label samples:





to

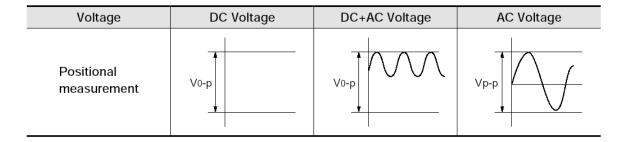
CERAMIC DISC CAPACITOR SAFETY RECOGNIZED,	DOE D24 00 F 02	** 00	D 15/20
5AC SERIES	POE-D26-00-E-03	Ver : 03	Page: 15 / 20

#### 9. Caution:

#### 9.1 Operating voltage

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range.

When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing these irregular voltage.



#### 9.2 Operating temperature and self-generated heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

#### 9.3 Test condition for withstanding voltage

#### (1) Test equipment

Test equipment for AC withstanding voltage should be used with the performance of the wave similar to 50/60 Hz sine wave.

If the distorted sine wave or over load exceeding the specified voltage value is applied, the defective may be caused.

#### (2) Voltage applied method

When the withstanding voltage is applied, capacitor's lead or terminal should be firmly connected to the out-put of the withstanding voltage test equipment, and then the voltage should be raised from near zero to the test voltage.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, test voltage should be applied with the \*zero cross. At the end of the test time, the test voltage should be reduced to near zero, and then capacitor's lead or terminal should be taken off the out-put of the withstanding voltage test equipment.

If the test voltage without the raise from near zero voltage would be applied directly capacitor, the surge voltage may arise, and therefore, the defective may be caused.

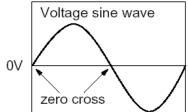
\*ZERO CROSS is the point where voltage sine wave pass 0V.

- See the right figure -

#### (3) Applied voltage

The voltages of Table shall be applied between the respective measuring points of 1 min for qualification approval and periodic testing and for a period of not less than 1 s for lot-by-lot quality conformance testing, a voltage proof test such as Test C shall be carried out only for qualification approval tests and periodic tests;

Attention is drawn to the fact that repetition of the voltage proof test by the user may damage the capacitor. If repetition of the voltage proof test is made by the user, the applied voltage should not be greater than 66 % of the test voltage specified in Table .





#### CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, POE-D26-00-E-03 Ver: 03 Page: 16 / 20 **5AC SERIES**

Table -Voltage proof

Class	Range of rated voltages	Test A	Test B or Test C
X1	≤1 000 V	4,3 UR (d.c.) c	2 UR + 1 500 V (a.c.) with a minimum of 2 000 V (a.c.) a
Y2	≥150 V ≤500 V	UR + 1 200 V (a.c.) with a minimum of 1 500 V (a.c.) b	2 UR + 1 500 V (a.c.) with a minimum of 2 000 V (a.c.) b

a For Delta and T-connected capacitor units according to Figures 5b and 5c, the test voltage for terminals to case shall be the appropriate test voltage for the Y-capacitors.

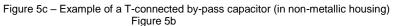
#### Note:

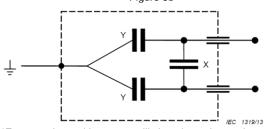
Test A - Between terminations

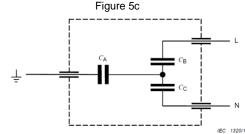
Test B - Internal insulation

Test C - External insulation (applicable only to insulated capacitors in nonmetallic case or in insulated metal case)

Figure 5b – Delta by-pass capacitor (in metallic housing)







\*For capacitors with non-metallic housings, the earth connection is brought out as a separate termination as is shown in Figure 5c.

#### 9.4 Fail-Safe

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

#### 9.5 Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

#### 9.6 Soldering

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron-tip: 400 °C max.

Soldering iron wattage: 50W max.

Soldering time: 3.5s max.

ь For lot-by-lot tests of Class Y2 capacitors, the a.c. test voltage may be replaced by a d.c. voltage of 1,5 times the prescribed a.c. voltage.

 $_{\text{c}}$  The UR in this d.c. test is the rated a.c.voltage value.



#### CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, POE-D26-00-E-03 Ver: 03 Page: 17 / 20 **5AC SERIES**

#### 9.7 Bonding, resin molding and coating

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of the bonded, molded or coated product in the intended equipment.

In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive, molding resin or coating may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

#### 9.8 Treatment after bonding, resin molding and coating

When the outer coating is hot (over 100  $^{\circ}$ C) after soldering, it becomes soft and fragile.

So please be careful not to give it mechanical stress.

Failure to follow the above cautions may result, worst case, in a short circuit and cause furning or partial dispersion when the product is used.

#### 9.9 Operating and storage environment

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed -10 to 40  $^{\circ}\mathrm{C}$  and 15 to 85%.

Use capacitors within 6 months after delivered. Check the solderability after 6 months or more.

#### 9.10 Limitation of applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- 1. Aircraft equipment
- 2. Aerospace equipment
- Undersea equipment
- Power plant control equipment
- Medical equipment
- Transportation equipment (vehicles, trains, ships, etc.)
- Traffic signal equipment
- Disaster prevention / crime prevention equipment
- 9. Data-processing equipment exerting influence on public
- 10. Application of similar complexity and/or reliability requirements to the applications listed in the above.

#### 10. Notices:

#### 10.1 Cleaning (ultrasonic cleaning):

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time: 5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.



#### CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, POE-D26-00-E-03 Ver: 03 **5AC SERIES**

#### 10.2 List of substances that affect the insulation strength of coating:

Epoxy resin solvent

Category	Model			
Ketone	Acetone	Butanone	Cyclohexanone	
Esters	Ethyl acetate	Dibutyl phthalate		
Chlorinated hydrocarbons	Dichloromethane			

Category		Model	
		HK-66 (Alkyl glycidyl ether)	
		501 (Butyl glycidyl ether)	
	Simple function group	690 (Phenyl Glycidyl Ether)	
		AGE (C12-14Aliphatic Polyalcohol Glycidyl Ether)	
		692 (Benzyl Glycidyl Ether)	
Reactive diluentactivated thinner		D-678 (Neopentyl glycol diglycidyl ether)	
		622 (1,4-Butanediol diglycidyl ether)	
	Two functional angues	669 (Ethylene glycol diglycidyl ether)	
	Two functional groups	X-632 (Polypropylene glycol diglycidyl ether)	
		X-652 (1,6-Hexadiol diglycidyl ether)	
		D-691Epoxypropane o-methylphenyl ether	
		Anhydrous ethanol	Toluene
		Ethyl acetate	Dimethylbenzene
Non-activated th	inner	Dimethyl formamide	Butyl acetate
		Acetone	Styrene
		Polyol	Benzyl alcohol

Note: The above substances should not contact the coating of the product body, otherwise it will affect the insulation strength of the product

#### 10.3 Capacitance change of capacitors

#### Class 1 capacitors

Capacitance might change a little depending on a surrounding temperature or an applied voltage.

Please contact us if you use for the strict time constant circuit.

#### Class 2 and 3 capacitors

Class 2 and 3 capacitors like temperature characteristic B, E and F have an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit.

Please contact us if you need a detail information.

#### 10.4 Performance check by equipment

Before using a capacitor, check that there is no problem in the equipment's performance and the specifications.

Generally speaking, CLASS 2 ceramic capacitors have voltage dependence characteristics and temperature dependence characteristics in capacitance. So, the capacitance value may change depending on the operating condition in a equipment. Therefore, be sure to confirm the apparatus performance of receiving influence in a capacitance value change of a capacitor, such as leakage current and noise suppression characteristic.

Moreover, check the surge-proof ability of a capacitor in the equipment, if needed, because the surge voltage may exceed specific value by the inductance of the circuit.

#### **11. Note**

- 11.1 Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- 11.2 You are requested not to use our product deviating from this specification.
- 11.3 Do not use these products in any Automotive Power train or Safety equipment including Battery charger for Electric Vehicles and Plug-in Hybrid.



CERAMIC DISC CAPACITOR SAFETY RECOGNIZED,	DOE D24 00 E 02	** 00	D 10 / 20
5AC SERIES	POE-D26-00-E-03	Ver : 03	Page: 19 / 20

#### 12. Soldering Recommendation:

#### 12.1 Wave Soldering Profile:

- Temperature conditions of the flow is recommended as shown in the chart
- Must implement the pre-heat
- Maximum peak flow temperature is recommended 265°C
- Time "T" implement in the chart recommended within 20 sec. it temperature exceed 200°C
- Take care with the flow solder not to touch the capacitor body directly at mounting

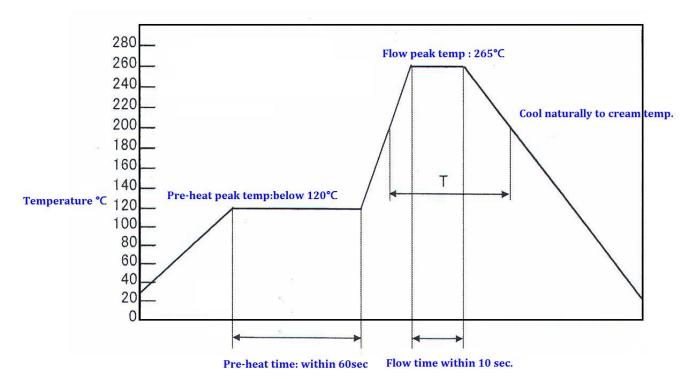


Chart to show flow recommended temp

#### 12.2 Recommended Reworking Conditions with Soldering Iron:

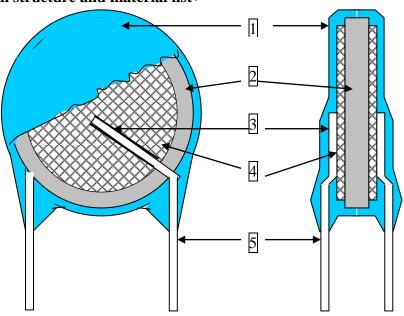
- Temperature of iron-tip: 400 degrees C. max.
- Soldering iron wattage: 50W max.
- Soldering time: 3.5 sec. max.
- Distance from coating body: 2 mm (min.)

#### 12.3 Reflow-Soldering: Lead Ceramic Cap. should not be soldered by reflow-soldering.



CERAMIC DISC CAPACITOR SAFETY RECOGNIZED,	DOT DO ( 00 T 00	** 00	20/20
5AC SERIES	POE-D26-00-E-03	Ver : 03	Page: 20 / 20

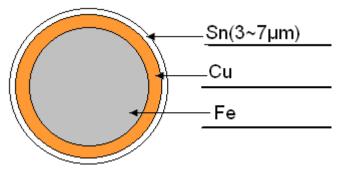
### 13. Drawing of internal structure and material list:



#### Remarks:

No.	Part name	Material	Model/Type	Component
1	Insulation Coating	Epoxy polymer	EF-150 ECP-357 PCE-300	Epoxy resin、Pigment (Blue / UL 94 V-0)
2	Dielectric Element	Ceramic	SL/Y5P/Y5U/Y5V	SL: SrCO3/TiO2/Bi2O3/CaCO3 Y5P: BaTiO3/Bi2O3/SnO2/CeO2 Y5U: BaTiO3/ZrO2/ CaCO3 Y5V: BaTiO3/ WO3/ CeO2
3	Solder	Tin-silver	Sn96.5-Ag3-Cu0.5	Sn96.5-Ag3-Cu0.5
4	Electrodes	Ag	SP-160PL SP-260PL	Confidentiality
5	Leads wire	Tinned copper clad steel wire	0.55+0.1/-0.05mm	Sn2.5 [Surface plating: Sn 100%(3~7μm)] \ Cu5 & Fe92.5 [Substrate metal]

### \*Constituent structure chart of lead



# 单击下面可查看定价,库存,交付和生命周期等信息

>>Walsin Technology(华新科技)